MOSFETs Silicon N-Channel MOS (DTMOSVI)

# TK040N60Z1

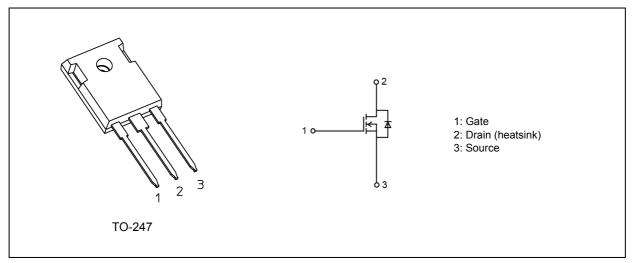
#### 1. Applications

• Switching Power Supplies

#### 2. Features

- (1) Low drain-source on-resistance:  $R_{DS(ON)} = 0.033 \Omega$  (typ.)
- (2) High-speed switching properties with lower capacitance.
- (3) Enhancement mode:  $V_{th}$  = 3 to 4 V ( $V_{DS}$  = 10 V,  $I_D$  = 2.4 mA)

#### 3. Packaging and Internal Circuit



#### 4. Absolute Maximum Ratings (Note) (T<sub>a</sub> = 25 °C unless otherwise specified)

Characteristics	Symbol	Rating	Unit	
Drain-source voltage		V <sub>DSS</sub>	600	V
Gate-source voltage		V <sub>GSS</sub>	±30	
Drain current (DC)	(Note 1)	Ι <sub>D</sub>	52	A
Drain current (pulsed)	(Note 1)	I <sub>DP</sub>	208	
Power dissipation $(T_c = 25 \text{ °C})$		PD	297	W
Single-pulse avalanche energy	(Note 2)	E <sub>AS</sub>	1049	mJ
Single-pulse avalanche current		I <sub>AS</sub>	8.0	A
Reverse drain current (DC)	(Note 1)	I <sub>DR</sub>	52	
Reverse drain current (pulsed)	(Note 1)	I <sub>DRP</sub>	208	
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature		T <sub>stg</sub>	-55 to 150	
Mounting torque		TOR	0.8	N · m

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Start of commercial production 2024-06

#### 5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	R <sub>th(ch-c)</sub>	0.420	°C/W
Channel-to-ambient thermal resistance	R <sub>th(ch-a)</sub>	50	

Note 1: Ensure that the channel temperature does not exceed 150 °C. Note 2:  $V_{DD}$  = 90 V,  $T_{ch}$  = 25 °C (initial), L = 29 mH,  $I_{AS}$  = 8.0 A

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

#### 6. Electrical Characteristics

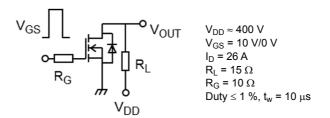
#### 6.1. Static Characteristics ( $T_a = 25$ °C unless otherwise specified)

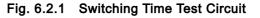
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I <sub>GSS</sub>	$V_{GS}$ = ±30 V, $V_{DS}$ = 0 V	_	_	±1	μA
Drain cut-off current	I <sub>DSS</sub>	$V_{DS}$ = 600 V, $V_{GS}$ = 0 V	_	—	2	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	600	—	—	V
Gate threshold voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 2.4 mA	3	_	4	
Drain-source on-resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 21.2 A		0.033	0.040	Ω

#### 6.2. Dynamic Characteristics ( $T_a = 25$ °C unless otherwise specified)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance		C <sub>iss</sub>	V <sub>DS</sub> = 300 V, V <sub>GS</sub> = 0 V, f = 100 kHz	_	5200	_	pF
Reverse transfer capacitance		C <sub>rss</sub>	]	_	4.0	_	
Output capacitance		C <sub>oss</sub>	]	_	120	_	
Effective output capacitance (energy related)	(Note 3)	C <sub>o(er)</sub>	$V_{DS}$ = 0 to 400 V, $V_{GS}$ = 0 V	—	200	—	
Effective output capacitance (time related)	(Note4)	C <sub>o(tr)</sub>	$V_{DS}$ = 0 to 400 V, $V_{GS}$ = 0 V	—	1450	—	
Gate resistance		rg	V <sub>DS</sub> = OPEN , f = 1 MHz	_	2.4	_	Ω
Switching time (rise time)		t <sub>r</sub>	See Fig.6.2.1		75	_	ns
Switching time (turn-on time)		t <sub>on</sub>	]	_	120	_	
Switching time (fall time)		t <sub>f</sub>	]		5	_	
Switching time (turn-off time)		t <sub>off</sub>	1	_	150	_	
MOSFET dv/dt ruggedness		dv/dt	$V_{DS} \leq V_{DSS}, \ I_D \leq 26 \ A$	120	_	_	V/ns

Note 3:  $C_{O(er)}$  is a fixed capacitance that gives the same stored energy as  $C_{OSS}$  while  $V_{DS}$  is rising from 0 V to 400 V. Note4:  $C_{O(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{OSS}$  while  $V_{DS}$  is rising from 0 V to 400 V.





#### 6.3. Gate Charge Characteristics ( $T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx 400$ V, $V_{GS}$ = 10 V, $I_{D}$ = 52 A	—	85	—	nC
Gate-source charge 1	Q <sub>gs1</sub>		_	29	_	
Gate-drain charge	Q <sub>gd</sub>		_	22		

#### 6.4. Source-Drain Characteristics ( $T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Diode forward voltage	V <sub>DSF</sub>	I <sub>DR</sub> = 52 A, V <sub>GS</sub> = 0 V	_	_	-1.7	V
Reverse recovery time	t <sub>rr</sub>	V <sub>DD</sub> = 400 V,	_	380	_	ns
Reverse recovery charge	Q <sub>rr</sub>	I <sub>DR</sub> = 26 A, V <sub>GS</sub> = 0 V -dI <sub>DR</sub> /dt = 100 A/μs	_	6.7	_	μC
Peak reverse recovery current	I <sub>rr</sub>	$-di_{DR}/dt = 100 A/\mu s$	_	35	_	А
Diode dv/dt ruggedness	dv/dt	$V_{DD} \leq 400$ V, $I_{DR} \leq 26$ A, $V_{GS}$ = 0 V	50		_	V/ns

#### 7. Marking (Note)

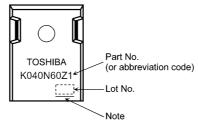


Fig. 7.1 Marking

Note: A line under a Lot No. identifies the indication of product Labels.

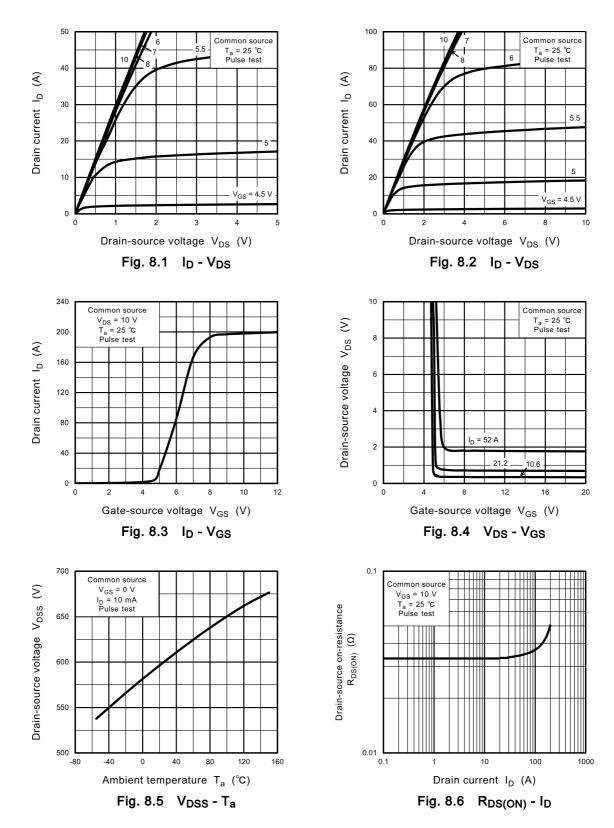
Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

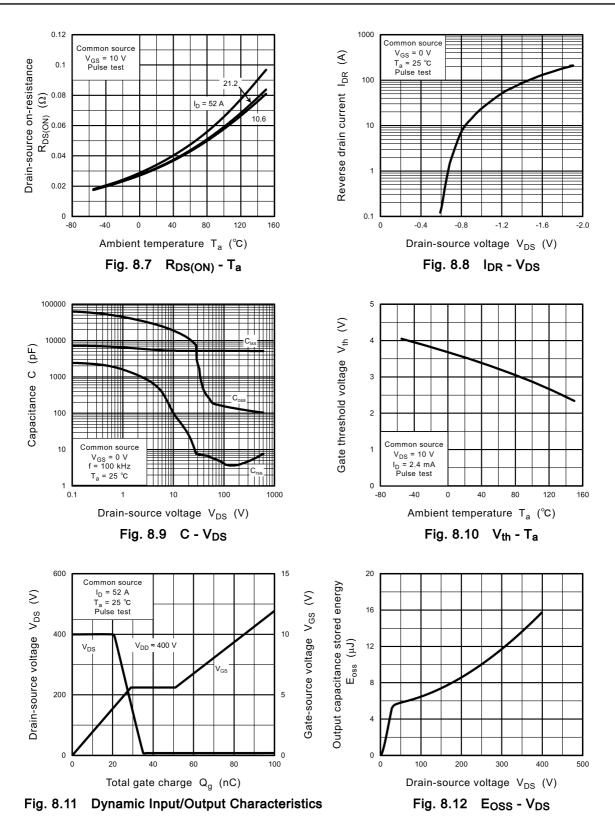
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

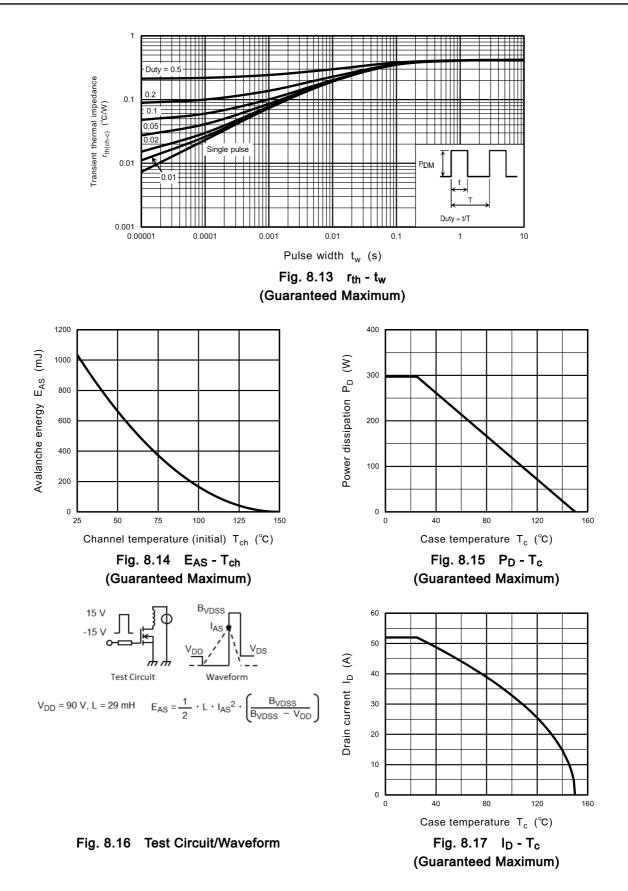
The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

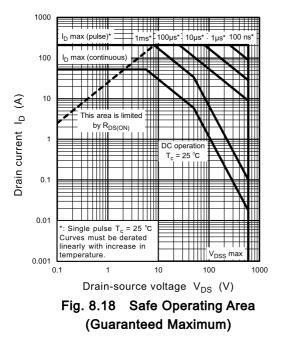
#### 8. Characteristics Curves (Note)









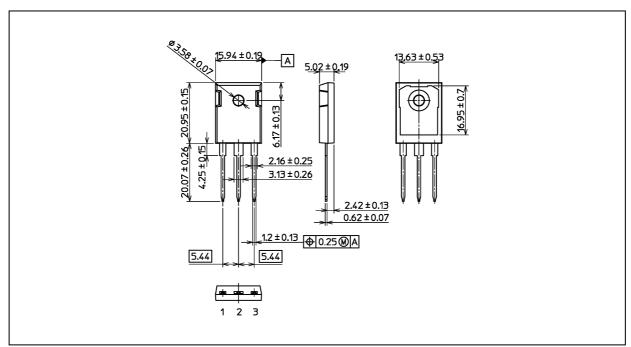


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

### TK040N60Z1

#### Package Dimensions

Unit: mm



Weight: 6.15 g (typ.)

	Package Name(s)
TOSHIBA: 2-16L1A	
Nickname: TO-247	

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